

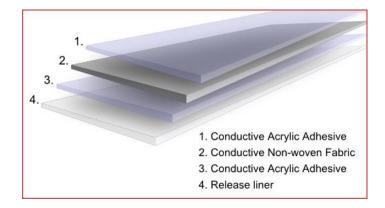
# Technical Data - HB350

## **Product description**

- Conductive Double Coated Acrylic Adhesive Tape
- Conductive Non-woven Fabric
- Conductive Acrylic Adhesive (Nickel Type)
- Tape for EMI/RFI Shielding

#### Construction

- Conductive Acrylic Adhesive
- Conductive Non-woven Fabric
- Conductive Acrylic Adhesive
- Release Liner



#### **Technical data**

Item		Unit	Spec.	Test Method
Thickness	Backing	μт	35±2	KSA 1107
	Total		50±2	
Peel Strength		g/25mm	1100	KSA 1107
				SUS 304
<b>Electrical Resistance Through</b>		Ω	0.05↓	HIOKI 3540
Adhesive				1Kg Pressure
Heat Resistance (Holding Power)		°C	Good	110°C / 500g
				Heating Oven

### Note

When applying EMI tape to any surface, be sure that the surface is free from Oil or other surface contaminates such as powder, dust or release agent. Adhesive performance should be carefully checked when used on substrates containing plasticizers.

Unless stated otherwise all values given are average. All of the tapes in our range should be thoroughly tested on the substrates in the particular application they are intended for. Hi-Bond Tapes Ltd. will not be responsible for product failure unless full testing has been completed. The customer has to decide on the tapes suitability for the intended application.





